Extend the pads on L5 so that the footprint could accommodate either the Murata part or the TDK ADL series part.
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These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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PCB Rev: E3

Assembly Note ZZ1
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note ZZ2
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note ZZ3
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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